

# RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS2290	Sep-97	9725 K	DALLAS	DA094872	PCB	SIPSTIK

**STRESS/JOB NO.**

**READPOINT**  
(Sample Size/No. of Fails)

Hi Temp Storage 85°C, No Bias P-20429	<u>336 Hr</u> 11/0	<u>1000 Hr</u>	<u>Cum %</u>
Temp Cycle -40°C to +85°C P-20430	<u>100 ~</u> 11/0	<u>500 ~</u>	<u>Cum %</u>
Moisture Soak 60°C / 90% R.H. P-20431	<u>192 Hr</u> 11/0	<u>384 Hr</u>	<u>Cum %</u>

**Failure Mode**

**Failure Analysis**